

| | Layer | Name | Material | Thickness | Constant | intan | omnet-intan | intan-drive |
|--|-------|---------------|---------------|-----------|----------|-------|-------------|-------------|
| | 1 | Fotolack | Solder Resist | | 3.5 | | | |
| | 2 | Top Layer | Copper | O. 012mm | | | | |
| | 3 | Dielectric 1 | FR-4 | 0.022mm | 4.2 | | | |
| | 4 | Adhesive 1 | | 0.025mm | 4.2 | | | |
| | 5 | GND | Copper | 0.012mm | | | | |
| | 6 | Adhesive 2 | | 0.025mm | 4.2 | | | |
| | 7 | Dielectric 2 | FR-4 | 0.022mm | 4.2 | | | |
| | 8 | Bottom layer | Copper | 0.012mm | | | | |
| | 9 | Bottom Solder | Solder Resist | | 3.5 | | | |
| 90 00 00 00 00 00 00 00 00 00 00 00 00 0 | | | | | | | | |

